CPI0806J4R7R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

Inductance(uH)

1



- B 1.60 [.063] ± 0.15[.006]
- C 0.90 [.035] ± 0.10[.004]
- D 0.50 [.020] ± 0.20[.008]

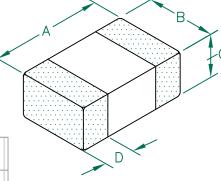
Ls vs Frequency

100

Frequency (MHz)

Ls vs DC BIAS Current

1.000



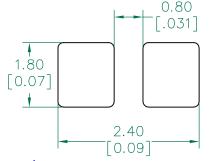


ELECTRICAL CHARACTERISTICS:										
	L (μΗ) @ 1MHz ± 20%	DCR ($\frac{\Omega}{2}$) ± 30%	l (Max)							
Nom	4.70	0.30								
Min	3.76	0.21								
Max	5.64	0.39	1100mA							

NOTES: UNLESS OTHERWISE SPECIFIED

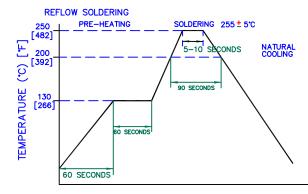
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL, EMBOSSED PLASTIC TAPE.
- 2. TERMINATION FINISH IS 100% MATTE Sn OVER Ni.
- COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. I (MAX.) IS BASED ON THE MAXIMUM SUSTAINED CURRENT APPLIED WHILE MAINTAINING A MAXIMUM TEMPERATURE RISE OF 40°C OVER AMBIENT.
- 5. OPERATION TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [0.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



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	DIMENSIONS ARE IN mm [INCHI	This print is the property of Lai							
				Tech. and is loaned in confidence subject to return upon request			= 5 ,		
				with the understanding that no		2	ľ	7	
				copies shall be made without th	L	Q.	ir(
				written consent of Laird Tech. A rights to design or invention are					
				reserved.					
		1		PROJECT/PART NUMBER:	-	REV	PART TYPE: D		DRAWN BY:
		 		CPI0806J4R7R-10		В	CO-FIRE		QU
\vdash		.		CI 100000+11711 10					
В	UPDATE LAIRD LOGO AND NOTES 5	08/05/13	QU	DATE: 03/01/11 S		SCALE: NTS		SHEET:	
Α	ORIGINAL DRAFT	03/01/11	QU	, ,	TOOL		13	_	
REV	DESCRIPTION	DATE	INT	CPI0806J4R7R-10-B	'''	•	-	2	of 2